TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7MZ574FK

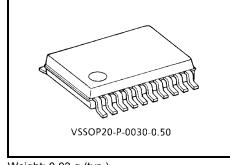
#### Low Voltage Octal D-Type Flip-Flop with 5 V Tolerant Inputs and Outputs

The TC7MZ574FK is a high performance CMOS octal D-type flip flop. Designed for use in 3.3 V systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (3.3 V)  $V_{\rm CC}$  applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

This 8 bit D-type flip-flop is controlled by a clock input (CK) and an output enable input ( $\overline{OE}$ ). When the  $\overline{OE}$  input is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge.

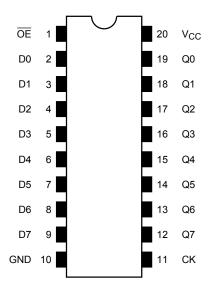


Weight: 0.03 g (typ.)

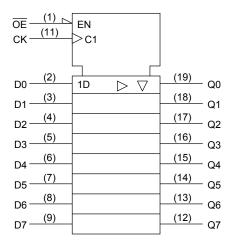
#### **Features**

- Low voltage operation: VCC = 2.0~3.6 V
- High speed operation:  $t_{pd} = 8.5 \text{ ns (max)} (V_{CC} = 3.0 \sim 3.6 \text{ V})$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min) (V}_{CC} = 3.0 \text{ V)}$
- Latch-up performance: -500 mA
- Package: VSSOP (US20)
- Power down protection is provided on all inputs and outputs.
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 574 type.

## Pin Assignment (top view)



## **IEC Logic Symbol**



## **Truth Table**

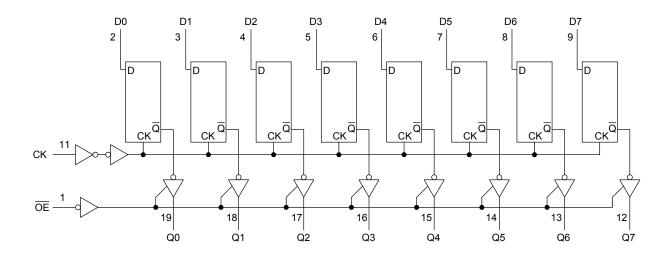
	Inputs				
ŌĒ	CK	D	Outputs		
Н	Х	Х	Z		
L	$\neg$	Х	Qn		
L		L	L		
L		Н	Н		

X: Don't care

Z: High impedance

Qn: No change

## **System Diagram**



## **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit	
Supply voltage range	V <sub>CC</sub>	-0.5~7.0	V	
DC input voltage	V <sub>IN</sub>	-0.5~7.0	V	
DC output voltage	Va	−0.5~7.0 (Note 2)	V	
DC output voltage	V <sub>OUT</sub>	-0.5~V <sub>CC</sub> + 0.5 (Note 3)	V	
Input diode current	I <sub>IK</sub>	-50	mA	
Output diode current	lok	±50 (Note 4)	mA	
DC output current	lout	±50	mA	
Power dissipation	PD	180	mW	
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA	
Storage temperature	T <sub>stg</sub>	-65~150	°C	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in off-state

Note 3: High or low state. I<sub>OUT</sub> absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

## **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub> 2.0~3.6		V
Supply voltage	vcc vcc	1.5~3.6 (Note 2)	V
Input voltage	V <sub>IN</sub>	0~5.5	٧
Output voltage	V <sub>OUT</sub>	0~5.5 (Note 3)	>
Output voltage	VOU1	0~V <sub>CC</sub> (Note 4)	
Output current	I <sub>OH</sub> /I <sub>OI</sub>	±24 (Note 5)	mA
Output current	'OH''OL	±12 (Note 6)	ША
Operating temperature	T <sub>opr</sub>	-40~85	°C
Input rise and fall time	dt/dv	0~10 (Note 7)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

3

Note 2: Data retention only

Note 3: Output in off-state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \sim 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \sim 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8 \sim 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$ 

## **Electrical Characteristics**

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## DC Characteristics ( $Ta = -40 \sim 85$ °C)

Characte	Characteristics Symbol Test Condition				Min	Mov	l lmit	
Characte	ensucs	Symbol			V <sub>CC</sub> (V)	IVIIN	Max	Unit
Input voltage	High level	$V_{IH}$		_	2.7~3.6	2.0	_	V
Input voltage	Low level	V <sub>IL</sub>		_	2.7~3.6	_	0.8	V
			V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -100 \ \mu A$	2.7~3.6	V <sub>CC</sub> - 0.2		V
	High level	V <sub>OH</sub>		$I_{OH} = -12 \text{ mA}$	2.7	2.2	_	
				$I_{OH} = -18 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2	_	
	V	Mary Mary 25 Mary	I <sub>OL</sub> = 100 μA	2.7~3.6	_	0.2		
			I <sub>OL</sub> = 12 mA	2.7	_	0.4		
	Low level V <sub>OL</sub>	VOL	OL VIN = VIH or VIL	I <sub>OL</sub> = 16 mA	3.0	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.55	
Input leakage cu	urrent	I <sub>IN</sub>	V <sub>IN</sub> = 0~5.5 V		2.7~3.6		±5.0	μΑ
3-state output off-state current I <sub>C</sub>		1	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = 0 \sim 5.5 \text{ V}$		2.7~3.6	_	±5.0	μА
		loz			2.7~3.0			
Power off leaka	ge current	l <sub>OFF</sub>	$V_{IN}/V_{OUT} = 5.5 \text{ V}$		0		10.0	μΑ
Quiescent supply current		laa	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7~3.6	_	10.0	
Quiescent suppi	y current	Icc	V <sub>IN</sub> /V <sub>OUT</sub> = 3.6~5.5 V		2.7~3.6		±10.0	μΑ
Increase in I <sub>CC</sub>	per input	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.7~3.6		500	



## AC Characteristics ( $Ta = -40 \sim 85$ °C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Maximum clock frequency	f	Figure 1, Figure 2	2.7	_	_	MHz
iviaximum clock frequency	f <sub>max</sub>	Figure 1, Figure 2	$3.3\pm0.3$	150	_	IVIITIZ
Dranagation delay time (CK O)	t <sub>pLH</sub>	Figure 1 Figure 2	2.7	_	9.5	20
Propagation delay time (CK-Q)	$t_{pHL}$	Figure 1, Figure 2	$3.3 \pm 0.3$	1.5	8.5	ns
Output anable time	t <sub>pZL</sub>	Figure 1 Figure 2	2.7	_	9.5	20
Output enable time	t <sub>pZH</sub>	Figure 1, Figure 3	$3.3 \pm 0.3$	1.5	8.5	ns
Output disable time	$t_{pLZ}$	Figure 4 Figure 2	2.7	_	7.0	ne
	t <sub>pHZ</sub>	Figure 1, Figure 3	$3.3 \pm 0.3$	1.5	6.5	ns
Minimum pulse width (CK)	t <sub>w (H)</sub>	Figure 1, Figure 2	2.7	3.3	_	ns
willimum puise widin (CK)	t <sub>w (L)</sub>	Figure 1, Figure 2	$3.3 \pm 0.3$	3.3	_	115
Minimum set-up time		Figure 1, Figure 2	2.7	2.5	_	20
willimum set-up time	t <sub>S</sub>		$3.3 \pm 0.3$	2.5	_	ns
Minimum hold time	4.	Figure 4 Figure 2	2.7	1.5	_	ne
	t <sub>h</sub>	Figure 1, Figure 2	$3.3\pm0.3$	1.5	_	ns
Output to output skew	t <sub>osLH</sub>	21.1	2.7	_	_	ne
	t <sub>osHL</sub>	(Note)	$3.3\pm0.3$	_	1.0	ns

Note: This parameter is guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

## **Dynamic Switching Characteristics**

(Ta = 25°C, Input:  $t_r = t_f = 2.5 \text{ ns}, C_L = 50 \text{ pF}, R_L = 500 \Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH}=3.3\ V,\ V_{IL}=0\ V$	3.3	8.0	٧
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V

## **Capacitive Characteristics (Ta = 25°C)**

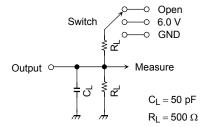
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz (Not	e) 3.3	25	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$ 

#### **AC Test Circuit**



Parameter	Switch
t <sub>pLH</sub> , t <sub>pHL</sub>	Open
t <sub>pLZ</sub> , t <sub>pZL</sub>	6.0 V
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND
t <sub>w</sub> , t <sub>s</sub> , t <sub>h</sub> , f <sub>max</sub>	Open

TC7MZ574FK

Figure 1

#### **AC Waveform**

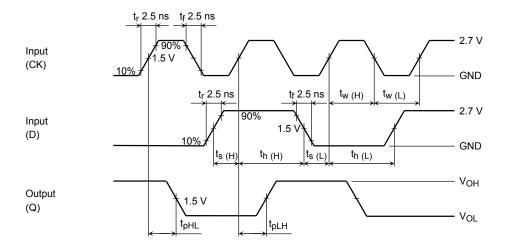


Figure 2  $t_{pLH}$ ,  $t_{pHL}$ ,  $t_w$ ,  $t_s$ ,  $t_h$ 

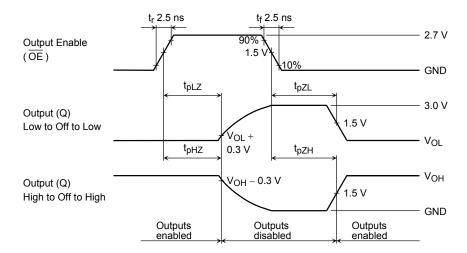
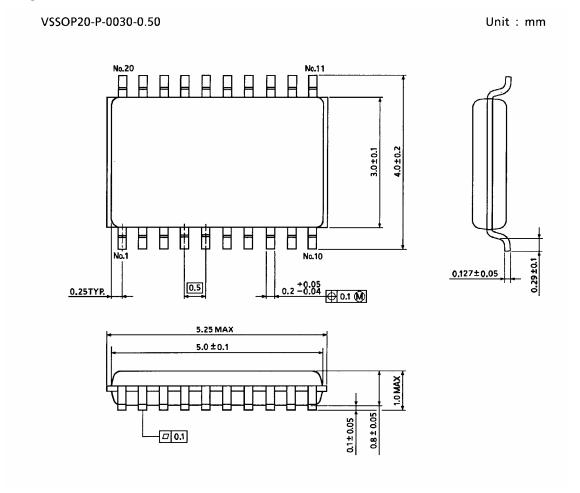


Figure 3  $\;t_{\text{pLZ}},\,t_{\text{pHZ}},\,t_{\text{pZL}},\,t_{\text{pZH}}$ 

## **Package Dimensions**



Weight: 0.03 g (typ.)

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20070701-EN GENERAL

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